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. Memory options for DIMM. I have the following memory config installed: (Note: SODIMM sticks are inserted into slot 1) Chip Select (CS) Memory Slot Memory Type Pins. Intel Pentium Processor D2XXxx Intel(R) Pentium(R) Dual CPU E2180 @ 2.00GHz.. Intel Pentium Dual Core CPU E5200 Video Driver/Software Changelog. In semiconductor manufacturing processes, particularly in photolithography processes using light or charged particles, a reduction in the width of a semiconductor device is desired in order to increase integration of the semiconductor device. In the semiconductor device, a multilayer film is formed in order to relax stress generated in a wafer. In the multilayer film, a wiring material, a resist, a resist pattern, a protective film, a hard mask material, an etching stopper, and an interlayer insulating film are generally stacked sequentially. When the multilayer film is formed, the temperature of a vacuum container for supplying a deposition material and the temperature of the wafer in which a multilayer film is formed must be raised to a certain level. In recent years, a fine processing technique has been used in photolithography. Therefore, it is preferable to use a deposition material having a low vapor pressure. In the case of a deposition material having a low vapor pressure, the amount of the deposition material adsorbed on a heat plate, an adhesion substrate, and a deposition material supplying apparatus increases with the decrease in the vapor pressure of the deposition material. However, when the temperature of the heat plate, the adhesion substrate, and the deposition material supplying apparatus is high, the amount of the deposition material adsorbed on the heat plate, the adhesion substrate, and the deposition material supplying apparatus may decrease. Therefore, conventionally, during a process in which the temperature of a vacuum container is increased, a dry box in which the temperature is lowered is arranged between the vacuum container and the vacuum container, and the temperature is raised while a wafer in which a multilayer film is formed is transferred to the vacuum container. Further, in order to smoothly transfer the wafer to the vacuum container, the wafer is received and transferred by a carrier capable of repeatedly receiving and releasing the wafer, and the carrier is mounted on a front surface of the vacuum container. In order to increase the throughput of the semiconductor manufacturing process, a

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